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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ravindranath Droopad	07/31/2007
Matthias Passlack	07/31/2007
Karthik Rajagopalan	07/31/2007

RECEIVING PARTY DATA

Name:	Freescale Semiconductor, Inc.
Street Address:	6501 William Cannon Drive West
Internal Address:	Law Department
City:	Austin
State/Country:	TEXAS
Postal Code:	78735

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11831394

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	MT10558ZP	
NAME OF SUBMITTER:	Michael J. Balconi-Lamica	

Total Attachments: 4

PATENT REEL: 019625 FRAME: 0775

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> PATENT REEL: 019625 FRAME: 0776

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, RAVINDRANATH DROOPAD, CHANDLER, AZ; MATTHIAS PASSLACK, CHANDLER, AZ; and, KARTHIK RAJAGOPALAN, CHANDLER, AZ, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in MOSFET DEVICE FEATURING A

SUPERLATTICE BARRIER LAYER AND METHOD (Docket No. MT10558ZP), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for

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the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

RAVINDRANATH DROOPAD

First Witness

SIGNATURE OF WITNESS

DATE: July 31, 207

SIGNATURE OF WITNESS

DATE: 07/31/07

(Month-Day-Year)

Regene A. Graen

PRINTED NAME OF WITNESS

Second Witness

DATE: 7/31/07

SIGNATURE OF WITNESS

DATE: 7/31/07

(Month-Day-Year)

PRINTED NAME OF WITNESS

MT10558ZP

MATTHIAS PASSLACK	DATE: July 31 2007
First Witness Signature of Witness	DATE: 07/31/07 (Month-Day-Year)
Regene A. Graen PRINTED NAME OF WITNESS	

Second Witness	
SIGNATURE OF WITNESS	DATE: 7/31/07 (Month-Day-Year)
PRINTED NAME OF WITNESS	

KARTHIK RAJAGOPALAN	DATE: July 31, 2007
First Witness LOLAL GROWN SIGNATURE OF WITNESS	DATE: 07/31/07 (Month-Day-Year)
Regene A. Comen PRINTED NAME OF WITNESS	

Second Witness		AND THE PERSONS AND THE PERSON	
SIGNATURE OF WITNESS	DATE:	7/3//07 (Month-Day-Year)	
PRINTED NAME OF WITNESS			

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PATENT REEL: 019625 FRAME: 0780